

SSC8644GS1

N and P-Channel Enhancement Mode Power MOSFET

> Features

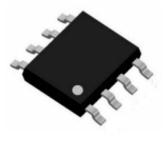
N-Channel

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	ID
40V	±20V	21mΩ@10V	8A
40 0	<u> </u>	27mΩ@4.5V	OA .

P-Channel

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	Ι _D
-40V	+20V	60mΩ@-10V	-4.7A
-40 V	<u> -</u> 20 v	70mΩ@-4.5V	- -

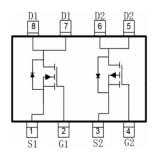
Pin configuration



SOP-8

> Description

The SSC8644GS1 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.



Pin Configuration (Top View)

Applications

- PWM Applications
- Load Switch
- DC-DC Converters
- Wireless Chargers

Ordering Information

Device	Package	Shipping
SSC8644GS1	SOP-8	4000/Reel



Marking (Top View)



➤ Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-to-Source Voltage	V _{DSS}	40	-40	V
Gate-to-Source Voltage	V _{GSS}	±20	±20	V
Continuous Drain Current °	lο	8	-4.7	А
Pulsed Drain Current ^b	I _{DM}	32	-18	Α
Power Dissipation ^c	P _D	2	2	W
Operation junction temperature	TJ	-55 to 150	-55 to 150	$^{\circ}$
Storage temperature range	Tstg	-55 to 150	-55 to 150	$^{\circ}$

➤ Thermal Resistance Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Channel	Ratings	Unit
R _θ JA	Junction-to-Ambient Thermal Resistance a	N-Channel	62	°C/W
R _{0JA}	Junction-to-Ambient Thermal Resistance a	P-Channel	62	C/VV

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper,in a still air environment with T_A=25 °C. The value in any given application depends on the user is specific board design. The current rating is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

SSC-V1.0 www.sscsemi.com Analog Future



ightarrow N-Channel Electrical Characteristics (T_A=25 $^{\circ}$ C unless otherwise noted)

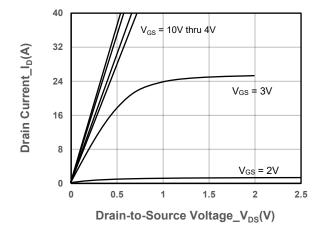
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250uA$	40			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250uA$	1	1.5	2.5	V
Drain Source On Registance	D	V _{GS} = 10V, I _D = 5.8A		21	33	m0
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5V, I _D = 5A		27	38	mΩ
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40V, V_{GS} = 0V$			1	μA
Gate-Source Leak Current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
Forward Voltage	V_{SD}	V _{GS} = 0V, I _S = 2A			1.3	V
Input Capacitance	Ciss	\\ - 00\\ \\ - 0\\		648		
Output Capacitance	Coss	$V_{DS} = 20V$, $V_{GS} = 0V$, $f = 1MHz$		55		pF
Reverse Transfer Capacitance	C _{RSS}	I - IIVIDZ		42		
Total Gate Charge	Q_{G}	\/ - 40\/ \/ - 20\/		12		
Gate to Source Charge	Q _G s	$V_{GS} = 10V, V_{DS} = 20V,$ $I_{D} = 4A$		2		nC
Gate to Drain Charge	Q _{GD}	ID - 4A		2.3		
Turn-on Delay Time	T _{D(ON)}			14		
Rise Time	Tr	$V_{GS} = 10V, V_{DS} = 20V,$		46		
Turn-off Delay Time	T _{D(OFF)}	$R_L = 2.5\Omega$, $R_{GEN} = 3\Omega$,		20		ns
Fall Time	Tf	,,		11		

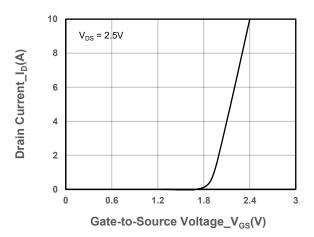
▶ P-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_{D} = -250uA$	-40			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250uA$	-1	-1.5	-2.5	V
Drain-Source On-Resistance	D	$V_{GS} = -10V$, $I_D = -3.2A$		60	78	mΩ
Dialii-Source Oil-Resistance	R _{DS(on)}	$V_{GS} = -4.5V$, $I_D = -2A$		70	95	11122
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -40V, V_{GS} = 0V$			-1	μA
Gate-Source Leak Current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
Transconductance	G _{FS}	V _{DS} = -10V, I _D = -4A		5		s
Forward Voltage	V_{SD}	V _{GS} = 0V, I _S = -2A			-1.3	V
Input Capacitance	C _{ISS}	\/ - 20\/ \/ - 0\/		540		
Output Capacitance	Coss	$V_{DS} = -20V, V_{GS} = 0V,$ f = 1MHz		50		pF
Reverse Transfer Capacitance	Crss	I - IIVITZ		41		
Total Gate Charge	Q _G	\\ - 00\\\\ - 40\\		14		
Gate to Source Charge	Q _{GS}	$V_{GS} = -20V, V_{DS} = -10V,$		2.8		nC
Gate to Drain Charge	Q _{GD}	I _D = -5A		3.6		
Turn-on Delay Time	T _{D(ON)}			9.5		
Rise Time	Tr	$V_{GS} = -10V, V_{DS} = -20V,$		8		
Turn-off Delay Time	T _{D(OFF)}	$R_L = 2\Omega$, $R_G = 3\Omega$		27		ns
Fall Time	T _f	,		9		



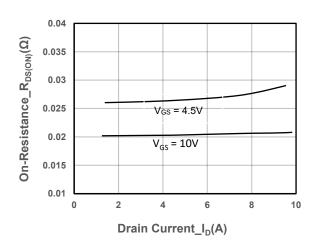
➤ N-Channel Typical Performance Characteristics (T_A=25°C unless otherwise noted)

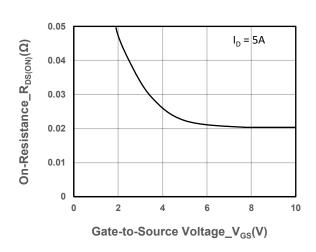




Output Characteristics

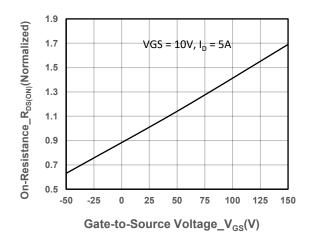


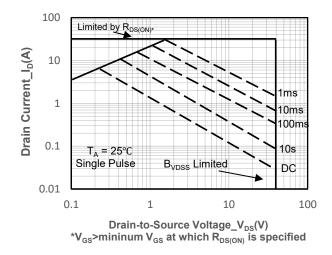




On-Resistance vs. Drain Current and Gate Voltag

On-Resistance vs. Gate-to-Source Voltage



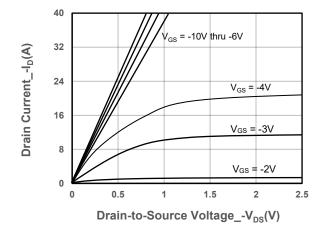


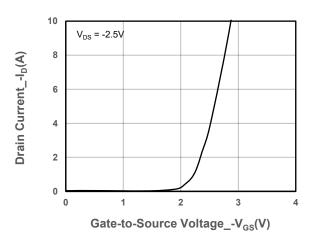
On-Resistance vs. Junction Temperature

Safe Operating Area vs. Junction-to-Ambient



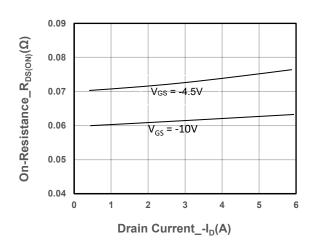
▶ P-Channel Typical Performance Characteristics (T_A=25°C unless otherwise noted)

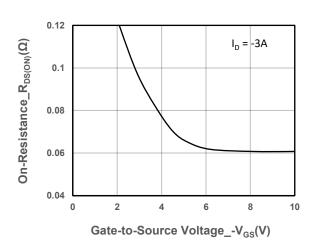




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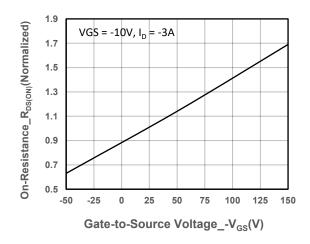


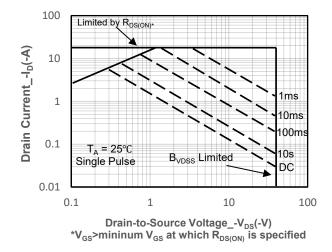




On-Resistance vs. Drain Current and Gate Voltag

On-Resistance vs. Gate-to-Source Voltage



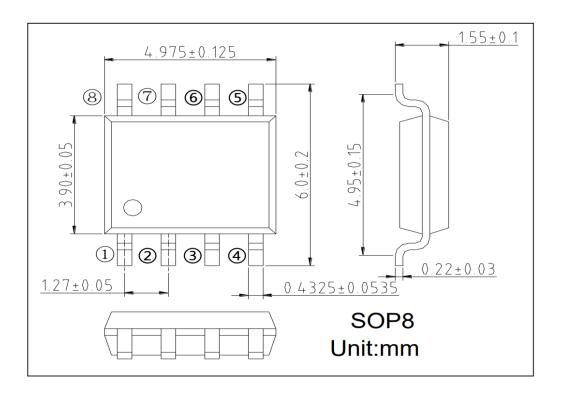


On-Resistance vs. Junction Temperature

Safe Operating Area vs. Junction-to-Ambient



Package Information



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